

UNISONIC TECHNOLOGIES CO., LTD

5N60

Power MOSFET

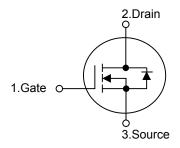
4.5 Amps, 600/650 Volts **N-CHANNEL MOSFET**

DESCRIPTION

The UTC 5N60 is a high voltage MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

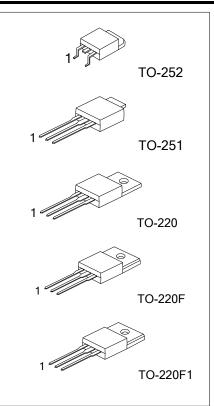
- * $R_{DS(ON)}$ = 2.5 Ω @V_{GS} = 10 V
- * Ultra Low Gate Charge (Typical 15 nC)
- * Low Reverse Transfer Capacitance (C_{RSS} = Typical 6.5 pF)
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness
- SYMBOL



ORDERING INFORMATION

Ordering Number		Deekege	Pin Assignment			Decking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
5N60L-x-TA3-T	5N60G-x-TA3-T	TO-220	G	D	S	Tube	
5N60L-x-TF3-T	5N60G-x-TF3-T	TO-220F	G	D	S	Tube	
5N60L-x-TF1-T	5N60G-x-TF1-T	TO-220F1	G	D	S	Tube	
5N60L-x-TM3-T	5N60G-x-TM3-T	TO-251	G	D	S	Tube	
5N60L-x-TN3-T	5N60G-x-TN3-T	TO-252	G	D	S	Tube	
5N60L-x-TN3-R	5N60G-x-TN3-R	TO-252	G	D	S	Tape Reel	

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■ **ABSOLUTE MAXIMUM RATINGS** (T_c = 25°C unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain Source Voltage	5N60-A	N/	600	V	
Drain-Source Voltage	5N60-B	V _{DSS}	650	v	
Gate-Source Voltage		V _{GSS}	±30	V	
Avalanche Current (Note 2)		I _{AR}	4.5	А	
Continuous Drain Current		Ι _D	4.5	А	
Pulsed Drain Current (Note 2)		I _{DM}	18	А	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	210	mJ	
	Repetitive (Note 2)	E _{AR}	10	IIIJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns	
Power Dissipation	TO-220	D	100	W	
	TO-220F/TO-220F1	P _D	36	vv	
	TO-251 / TO-252		54		
Junction Temperature	Temperature		+150	°C	
Operation Temperature		T _{OPR}	-55 ~ +150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Pulse width limited by $T_{J(MAX)}$

3. L = 18.9mH, I_{AS} = 4.5 A, V_{DD} = 50V, R_G = 25 $\Omega,$ Starting T_J = 25 $^\circ\mathrm{C}$

4. I_{SD} \leq 4.5A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25 $^{\circ}\mathrm{C}$

THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT	
Junction-to-Ambient	TO-220		62.5	°C/W	
	TO-220F/TO-220F1	θ _{JA}	62.5		
	TO-251 / TO-252		160		
Junction-to-Case	TO-220		1.25	°C/W	
	TO-220F/TO-220F1	θ _{JC}	3.47		
	TO-251 / TO-252		2.3		



■ ELECTRICAL CHARACTERISTICS (T_c = 25°C unless otherwise specified)

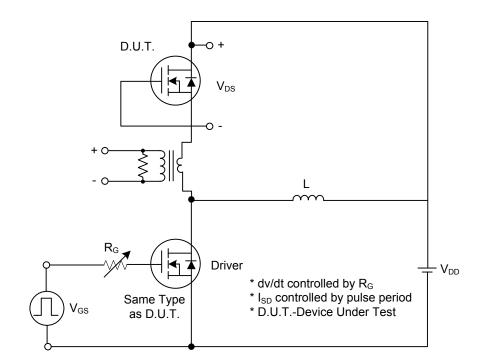
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	5N60-A		V _{GS} =0V, I _D = 250µA	600			v
	5N60-B	BV _{DSS}	V _{GS} =0V, I _D = 250µA	650			v
Drain-Source Leakage Current		I _{DSS}	V _{DS} =600V, V _{GS} = 0V			1	μA
Gate-Source Leakage Current	Forward		V _{GS} =30V, V _{DS} = 0V			100	nA
	Reverse		V_{GS} =-30V, V_{DS} = 0V			-100	ПА
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS} / \triangle T_J$	I_D =250µA, Referenced to 25°C		0.6		V/° C
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D = 250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D = 2.25A		2.0	2.5	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C _{ISS}	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz		515	670	рF
Output Capacitance Reverse Transfer Capacitance		C _{oss}			55	72	рF
		C _{RSS}			6.5	8.5	рF
SWITCHING CHARACTERISTIC	S				-	-	-
Turn-On Delay Time		t _{D(ON)}			10	30	ns
Turn-On Rise Time		t _R	V _{DD} = 300V, I _D =4.5 A,		42	90	ns
Turn-Off Delay Time		t _{D(OFF)}	R _G = 25Ω (Note 1, 2)		38	85	ns
Turn-Off Fall Time		t _F			46	100	ns
Total Gate Charge		Q _G	V _{DS} = 480 V, I _D = 4.5A,		15	19	nC
Gate-Source Charge		Q _{GS}	$V_{GS} = 400 \text{ V}, \text{ ID} = 4.5\text{A},$ - $V_{GS} = 10 \text{ V} (\text{Note } 1, 2)$		2.5		nC
Gate-Drain Charge		Q_{GD}			6.6		nC
DRAIN-SOURCE DIODE CHARA	CTERIST	ICS AND MAX	(IMUM RATINGS			-	-
Drain-Source Diode Forward Voltage		V _{SD}	V _{GS} = 0 V, I _S = 4.5 A			1.4	V
Maximum Continuous Drain-Source Diode		I _S				4.5	А
Forward Current						J	
Maximum Pulsed Drain-Source Diode		I _{SM}				18	А
Forward Current							
Reverse Recovery Time		t _{RR}	$V_{GS} = 0 V, I_{S} = 4.5 A,$		300		ns
Reverse Recovery Charge		Q _{RR}	d _{IF} / dt = 100 A/µs (Note 1)		2.2		μC

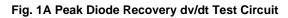
Note 1. Pulse Test: Pulse width \leq 300µs, Duty cycle \leq 2%

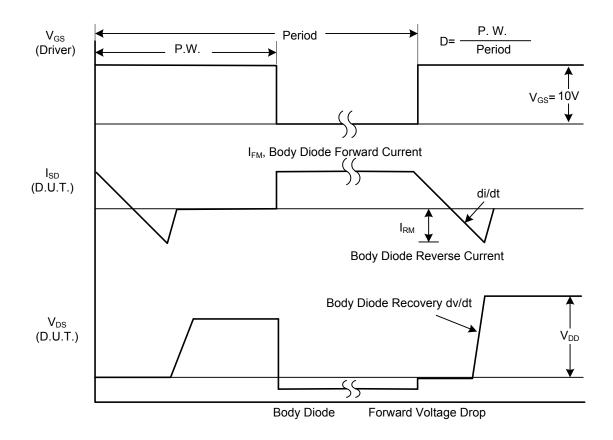
2. Essentially independent of operating temperature

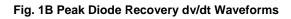


TEST CIRCUITS AND WAVEFORMS











■ TEST CIRCUITS AND WAVEFORMS (Cont.)

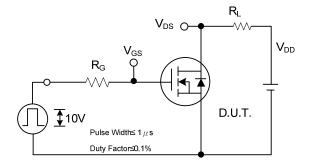


Fig. 2A Switching Test Circuit

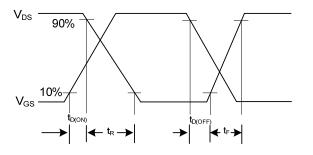


Fig. 2B Switching Waveforms

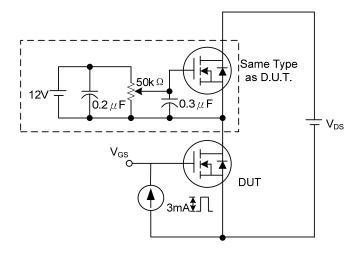


Fig. 3A Gate Charge Test Circuit

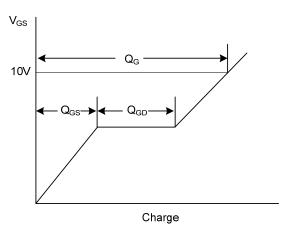


Fig. 3B Gate Charge Waveform

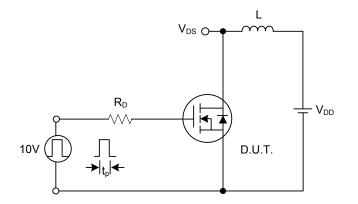


Fig. 4A Unclamped Inductive Switching Test Circuit

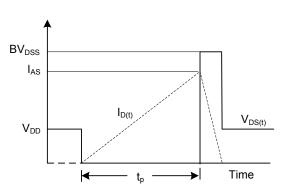
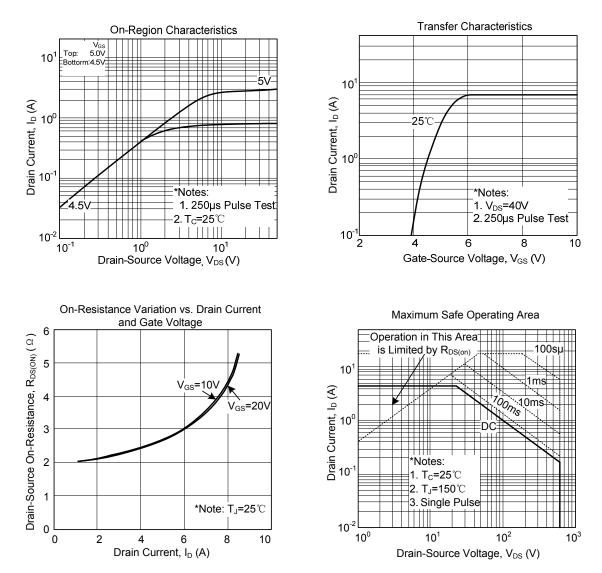


Fig. 4B Unclamped Inductive Switching Waveforms

TYPICAL CHARACTERISTICS



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